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Part Number:

0783590111

Status:

Active

Overview:

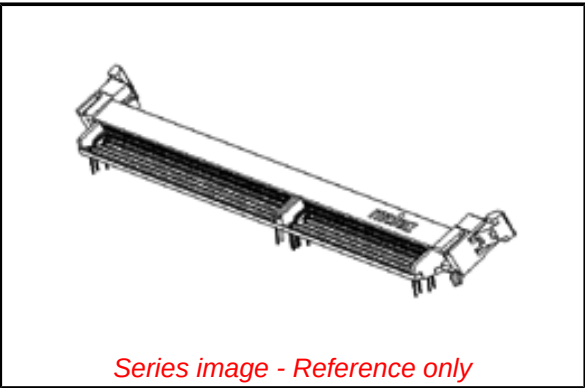
DDR3 DIMM Sockets

Description:

1.00mm Pitch DDR3 DIMM Socket, Very Low Profile, 25° Angle, Through Hole, with Beveled Metal Pins, Black Housing and Latches, 0.76µm Gold (Au) Plating, 4.00mm Solder Tail Length, 2.59mm PCB Thickness, 1.5V Center Voltage Key,

Documents:	
3D Model	Product Specification PS-78359-001 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E29179
General	
Product Family	Memory Module Sockets
Series	78359
Application Tooling Part Link	62100-1960
Component Type	Socket
Electrical Model	Yes
JEDEC Outline	MO-269
Overview	DDR3 DIMM Sockets
Product Name	DDR3 DIMM
UPC	883906302191
Physical	
Circuits (Loaded)	240
Circuits (maximum)	240
Color - Resin	Black
Durability (mating cycles max)	25
Entry Angle	25° Angle
Flammability	94V-0
Function Key	None
Keying to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	10.746/g
PC Tail Length	4.00mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	2.59mm
Packaging Type	Tray
Pitch - Mating Interface	1.00mm
Pitch - Termination Interface	1.00mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55°C to +85°C
Termination Interface: Style	Through Hole
Electrical	
Current - Maximum per Contact	1.0A
Voltage - Maximum	30V AC (RMS)/DC
Voltage Key	Center
Solder Process Data	



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

REACH SVHC

Contains SVHC(2014

December 17): No

Halogen-Free

Status

Not Low-Halogen

Need more information on product

environmental compliance?

Email productcompliance@molex.com

Please visit the [Contact Us](#) section for any

non-product compliance questions.

China ROHS

Green Image

ELV

Not Relevant

Search Parts in this Series

78359 Series

Mates With

JEDEC Standard 1.27mm Modules

Application Tooling | FAQ

Tooling specifications and manuals are

found by selecting the products below.

Crimp Height Specifications are then

contained in the Application Tooling

Specification document.

Global

Description

Product #

MiniDIMM Memory

0621001960

Card Insertion Tool

Duration at Max. Process Temperature (seconds)	010
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	002
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Electrical Model Document	EE-78359-001
Product Specification	PS-78359-001
S-Parameter Model	SP-78359-001
Sales Drawing	SD-78359-001

This document was generated on 08/18/2015

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